

REMARKS

In accordance with the foregoing claim 2 has been amended. Claims 2-11 are pending and under consideration. Claims 1 and 12-20 have been withdrawn from consideration. Claim 7 has been cancelled.

The Examiner is again respectfully requested to acknowledge the claim for the benefit of Japanese Application 2003-078354 (filed March 20, 2003) and receipt of the certified copy of the priority document.

In the Final Office Action mailed September 29, 2006, claims 2-6 and 9-11 were rejected under 35 U.S.C. 103 as being unpatentable over the Admitted Prior Art (APA) figures 18-21 in view of Oda 9JP08-27414), and claim 8 was rejected under 35 U.S.C. 103 as being unpatentable over the Admitted Prior Art in view of Oda and further in view of Umezawa (U.S. Patent No. 5,990,550). The foregoing rejections are respectfully traversed.

Claim 2 of the present application recites a packaging structure for electronic parts comprising "a first substrate having an opening" , " a hard resin filling an interior of the opening", in which the "first substrate" includes "a sustaining member provided within the opening, bonded to an inner peripheral surface of the opening and sustaining an exposed surface of the resin" (as amended).

Neither the Admitted Prior Art nor Oda discusses or suggests that a first substrate includes "a sustaining member provided within the opening, bonded to an inner peripheral surface of the opening and sustaining an exposed surface of the resin" as recited in amended claim 2.

In contrast to the present invention, in Oda, an electronic part 2 is not bonded to an inner peripheral surface of an opening.

Umezawa does not cure the defects of either the Admitted Prior Art or Oda.

Advantageously, in the present invention, a hard resin and a sustaining member sustain the weights of a second substrate, a first electronic part, and a second electronic part.

Withdrawal of the rejections of claims 2-6 and 8-11 is respectfully requested.

There being no further outstanding objections or rejections, it is submitted that the application is in condition for allowance. An early action to that effect is courteously solicited.


Finally, if there are any formal matters remaining after this response, the Examiner is requested to telephone the undersigned to attend to these matters.

If there are any additional fees associated with filing of this Amendment, please charge the same to our Deposit Account No. 19-3935.

Respectfully submitted,

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